

As a below-named inventor, I hereby declare that:

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

**the specification of which
(check one)**

 was filed on as

and was amended on _____
(if applicable)

I acknowledge the duty to disclose information of which I am aware which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, Section 1.56(a).

Prior Foreign Application(s)			Priority Claimed	
<u>Number</u>	<u>Country</u>	<u>Filing Date</u>	<u>Yes</u>	<u>No</u>
<u>P2000-394378</u>	<u>Japan</u>	<u>December 26, 2000</u>	<u>X</u>	

<u>Application Serial No.</u>	<u>Filing Date</u>	<u>Status</u>
_____	_____	_____

Please address all communications, and direct all telephone calls, regarding this application to

Reg. No. 27,213

Full name of sole or
First joint inventor Shigeru Kaneko

Inventor's signature _____

Citizenship Japanese Date of Signature _____

Residence Kanagawa, Japan

Post Office Address c/o Sony Corporation, 7-35 Kitashinagawa, 6-chome,
Shinagawa-ku, Tokyo, Japan